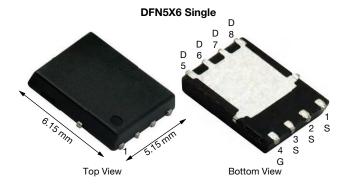


100N03MS-VB Datasheet N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^{a, e}	Q _g (Typ)			
30	0.00 at V _{GS} = 10 V	80	31 nC			
	0.0 at V _{GS} = 4.5 V	60	31110			



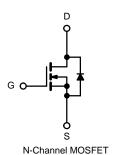
FEATURES

- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2011/65/EU



APPLICATIONS

- OR-ing
- Server
- DC/DC



Parameter	Symbol	Limit		Unit		
Drain-Source Voltage	V _{DS}	;	30	V		
Gate-Source Voltage	V_{GS}	± 20		V		
	T _C = 25 °C		80			
Continuous Drain Current (T = 175 °C)	T _C = 70 °C	I _D	60			
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C		5 b, c		A	
	T _A = 70 °C		4 b, c			
Pulsed Drain Current		I _{DM}				
Avalanche Current Pulse	1 0411	I _{AS}	60	60		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	5			
Continuous Source-Drain Diode Current	T _C = 25 °C	I-	80			
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	60		A A	
Maximum Power Dissipation	T _C = 25 °C	D	155		W	
Maximum Fower Dissipation	T _C = 70 °C	P_{D}	105			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175		°C	
THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 sec	R _{thJA}	32	40	00/14/	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.5 0.6		°C/W	

- a. Based on T_C = 25 °C.
 b. Surface mounted on 1" x 1" FR4 board.

- d. Maximum under steady state conditions is 90 °C/W.
 e. Calculated based on maximum junction temperature. Package limitation current is 90 A.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		35		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 7.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.5		2.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Comment	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	90			Α	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 0.8 \text{ A}$		0.00		Ω	
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_{D} = 7 \text{ A}$		0.0			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 0.8 \text{ A}$		160		S	
Dynamic ^b					L	L	
Input Capacitance	C _{iss}				1180		
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$			425	pF	
Reverse Transfer Capacitance	C _{rss}				170		
T. (10) (1)	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 0.8 \text{ A}$			61	nC	
Total Gate Charge	Qg				31.5		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 7.8 \text{ A}$			10		
Gate-Drain Charge	Q _{gd}				6		
Gate Resistance	R _g	f = 1 MHz		1.4	2.1	Ω	
Turn-On Delay Time	t _{d(on)}			18	27		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 0.625 \Omega$		11	17	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 24$ A, V_{GEN} = 10 V, R_g = 1 Ω		70	105		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			55	83		
Rise Time	t _r	V_{DD} = 15 V, R_{L} = 0.67 Ω		180	270		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 22.5~A,~V_{GEN}=4.5~V,~R_g=1~\Omega$		55	83		
Fall Time	t _f			12	18		
Drain-Source Body Diode Characteristic	s			L			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C					
Pulse Diode Forward Current ^a	I _{SM}					A	
Body Diode Voltage	V _{SD}	I _S = 22 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			52	78	ns	
Body Diode Reverse Recovery Charge Q		1 00 A JULIU 400 A / T 07 00		70.2	105	nC	
Reverse Recovery Fall Time	t _a	$I_F = 20 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 \text{ °C}$		27		ns	
Reverse Recovery Rise Time	t _b			25			

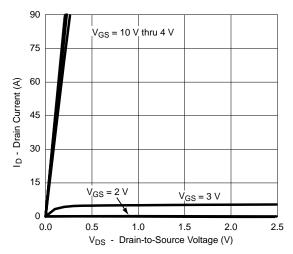
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

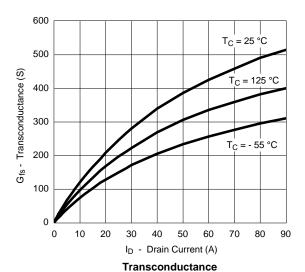
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



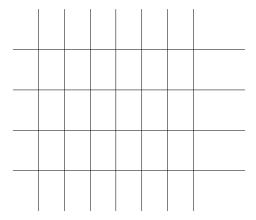
Output Characteristics



200 C_{iss} 900 900 900 900 0 6 12 18 24 30

 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:VDS} \textbf{Capacitance}$

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

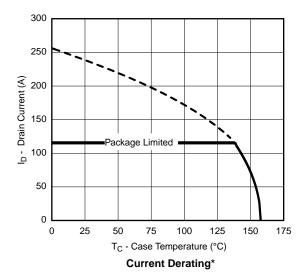


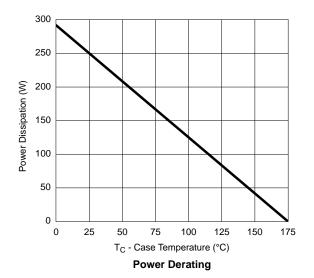
On-Resistance vs. Junction Temperature

 $R_{DS(on)}$ vs. V_{GS} vs. Temperature

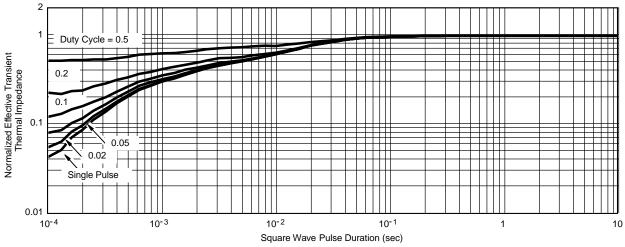


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





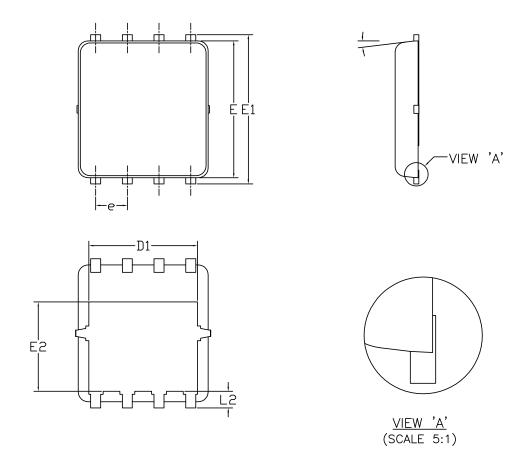
*The power dissipation P_D is based on $T_{J(max)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

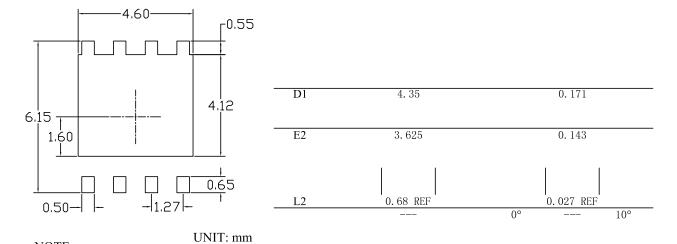


Normalized Thermal Transient Impedance, Junction-to-Case

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NOTE
1. PACKAGE BODY SIZES EX



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